## 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD123W small and flat lead Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 1 A
- Reverse voltage: V<sub>R</sub> ≤ 60 V
- · Extremely low leakage current
- Low forward voltage
- · High power capability due to clip-bonding technology
- Small and flat lead SMD plastic package
- AEC-Q101 qualified
- High temperature T<sub>i</sub> ≤ 175 °C
- · capable for reflow and wave soldering

# 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- · Reverse polarity protection

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F</sub>	forward current	T <sub>sp</sub> = 165 °C		-	-	1.4	Α
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{amb} \le 140 ^{\circ}\text{C}$ ; square wave	[1]	-	-	1	А
		$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le 170 ^{\circ}\text{C}$ ; square wave		-	-	1	А
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	60	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C		-	460	530	mV
I <sub>R</sub>	reverse current	$V_R = 60 \text{ V; } t_p \le 300  \mu\text{s; } \delta \le 0.02;$ $T_j = 25 \text{ °C; pulsed}$		-	30	60	μА
t <sub>rr</sub>	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 ^{\circ}\text{C}$		-	4.4	-	ns

[1] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.



High-temperature 60 V, 1 A Schottky barrier rectifier

# 5. Pinning information

### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	1 2	к <del>_<b>[</b>К]</del>
2	А	anode	CFP3 (SOD123W)	sym001

<sup>[1]</sup> The marking bar indicates the cathode.

## 6. Ordering information

#### **Table 3. Ordering information**

Table of Gracing morniation						
Type number	Package					
	Name	Description	Version			
PMEG6010ETR	CFP3	plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body	SOD123W			
PMEG6010ETR/S500	CFP3	plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body	SOD123W			

## 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG6010ETR	EK
PMEG6010ETR/S500	EK

High-temperature 60 V, 1 A Schottky barrier rectifier

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	60	V
I <sub>F</sub>	forward current	T <sub>sp</sub> = 165 °C		-	1.4	Α
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{amb} \le 140$ °C; square wave	[1]	-	1	А
		$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le 170$ °C; square wave		-	1	А
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	50	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2]	-	680	mW
			[3]	-	1.15	W
			[1]	-	2.14	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

- [1] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient		[1] [2]	-	-	220	K/W
			[1] [3]	-	-	130	K/W
			[1] [4]	-	-	70	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		<u>[5]</u>	-	-	18	K/W

<sup>[1]</sup> For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.

<sup>[2]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

<sup>[4]</sup> Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.

<sup>[5]</sup> Soldering point of cathode tab.

### High-temperature 60 V, 1 A Schottky barrier rectifier

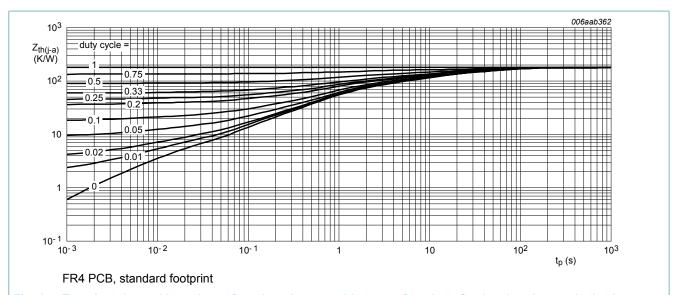


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

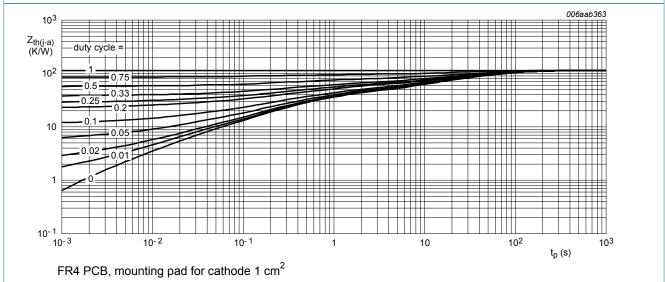
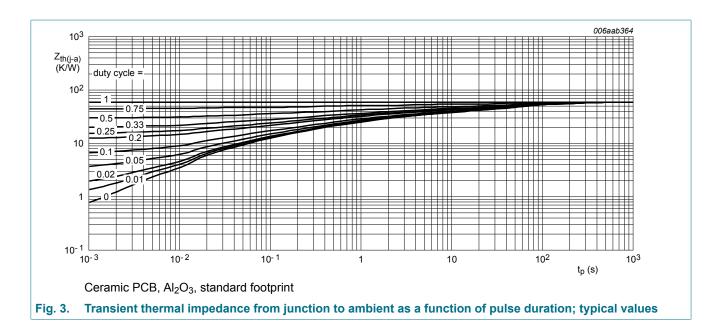


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## High-temperature 60 V, 1 A Schottky barrier rectifier



## 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{F}$	forward voltage	I <sub>F</sub> = 0.1 A; T <sub>j</sub> = 25 °C	-	320	370	mV
		I <sub>F</sub> = 0.7 A; T <sub>j</sub> = 25 °C	-	430	490	mV
		I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C	-	460	530	mV
		I <sub>F</sub> = 1 A; T <sub>j</sub> = -40 °C	-	510	590	mV
		I <sub>F</sub> = 1 A; T <sub>j</sub> = 125 °C	-	400	480	mV
		I <sub>F</sub> = 1 A; T <sub>j</sub> = 150 °C	-	380	460	mV
		I <sub>F</sub> = 1 A; T <sub>j</sub> = 175 °C	-	365	450	mV
I <sub>R</sub>	reverse current	$V_R = 5 \text{ V}; t_p \le 300 \text{ µs}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	-	1.2	-	μΑ
		$V_R = 10 \text{ V}; t_p \le 300 \text{ µs}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	-	1.7	-	μΑ
		$V_R = 60 \text{ V}; t_p \le 300 \text{ µs}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	-	30	60	μΑ
		$V_R = 60 \text{ V; } t_p \le 300  \mu\text{s; } \delta \le 0.02;$ $T_j = -40 \text{ °C; pulsed}$	-	0.6	10	μΑ
		$V_R = 60 \text{ V; } t_p \le 300  \mu\text{s; } \delta \le 0.02;$ $T_j = 125 \text{ °C; pulsed}$	-	14	50	mA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	120	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	40	-	pF
t <sub>rr</sub>	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$	-	4.4	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 1 \text{ A; } dI_F/dt = 40 \text{ A/}\mu\text{s; } T_j = 25 \text{ °C}$	-	500	-	mV

### High-temperature 60 V, 1 A Schottky barrier rectifier

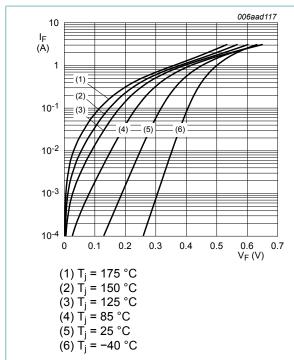


Fig. 4. Forward current as a function of forward voltage; typical values

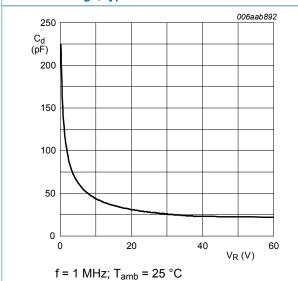


Fig. 6. Diode capacitance as a function of reverse voltage; typical values

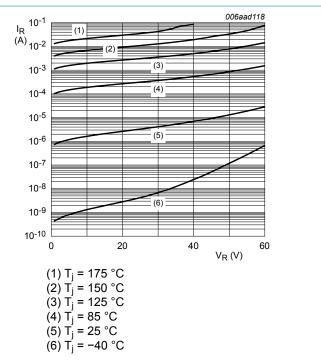
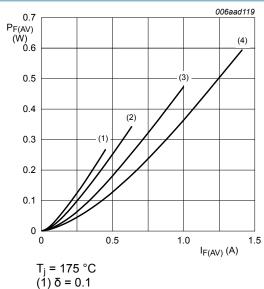


Fig. 5. Reverse current as a function of reverse voltage; typical values



 $f_j = 175 \text{ C}$   $(1) \delta = 0.1$   $(2) \delta = 0.2$   $(3) \delta = 0.5$  $(4) \delta = 1$ 

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

### High-temperature 60 V, 1 A Schottky barrier rectifier

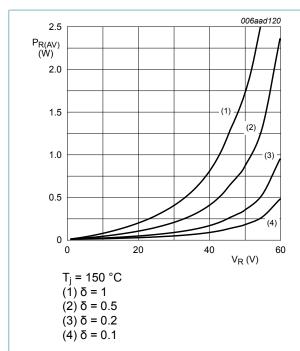


Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values

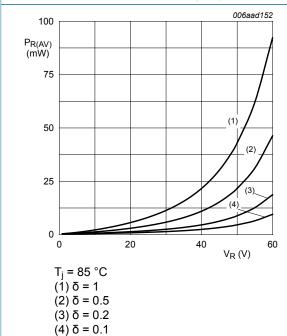


Fig. 10. Average reverse power dissipation as a function of reverse voltage; typical values

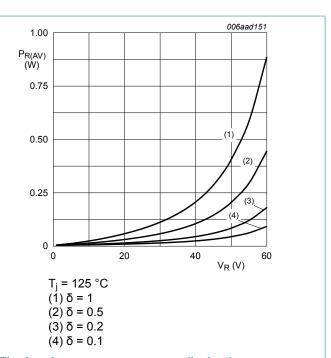


Fig. 9. Average reverse power dissipation as a function of reverse voltage; typical values

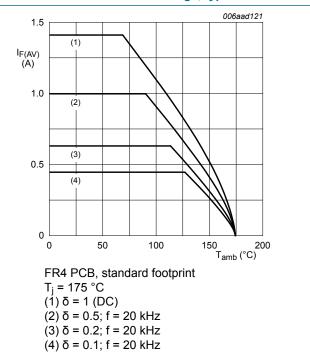
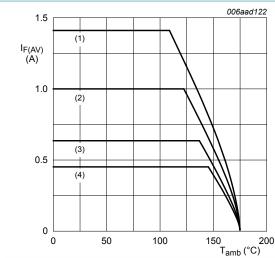


Fig. 11. Average forward current as a function of ambient temperature; typical values

### High-temperature 60 V, 1 A Schottky barrier rectifier



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

T<sub>i</sub> = 175 °C

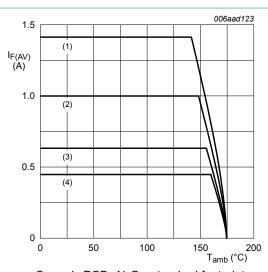
 $(1) \delta = 1 (DC)$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 12. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

 $T_i = 175$  °C

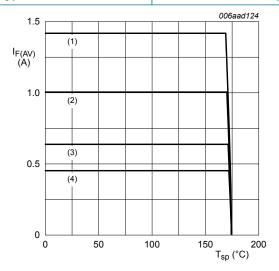
 $(1) \delta = 1 (DC)$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 13. Average forward current as a function of ambient temperature; typical values



 $T_i = 175 \,{}^{\circ}\text{C}$ 

 $(1) \delta = 1 (DC)$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

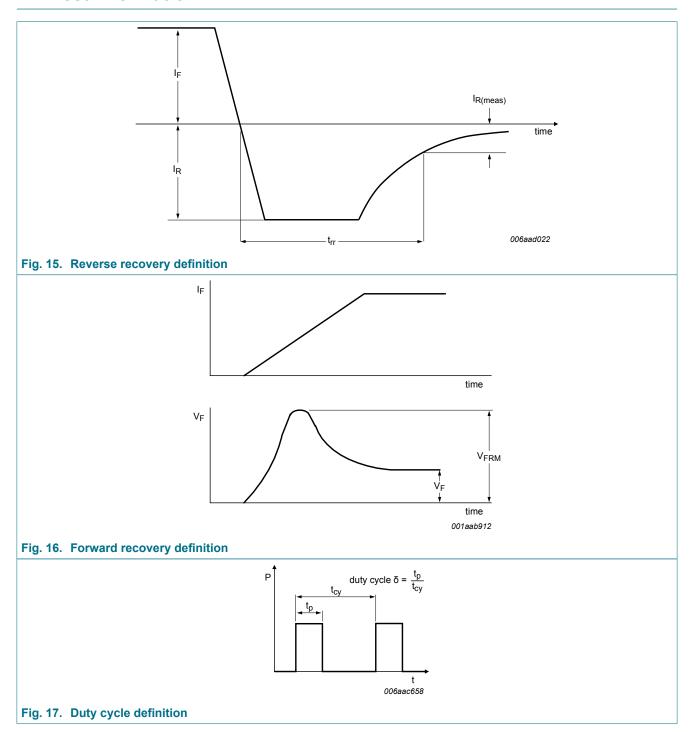
(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 14. Average forward current as a function of solder point temperature; typical values

High-temperature 60 V, 1 A Schottky barrier rectifier

## 11. Test information



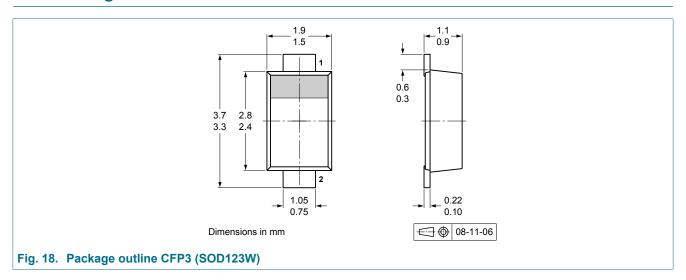
The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

## High-temperature 60 V, 1 A Schottky barrier rectifier

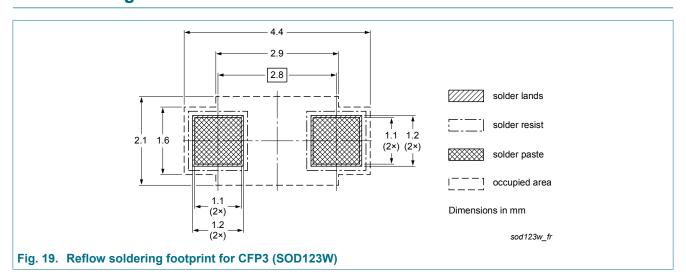
## **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

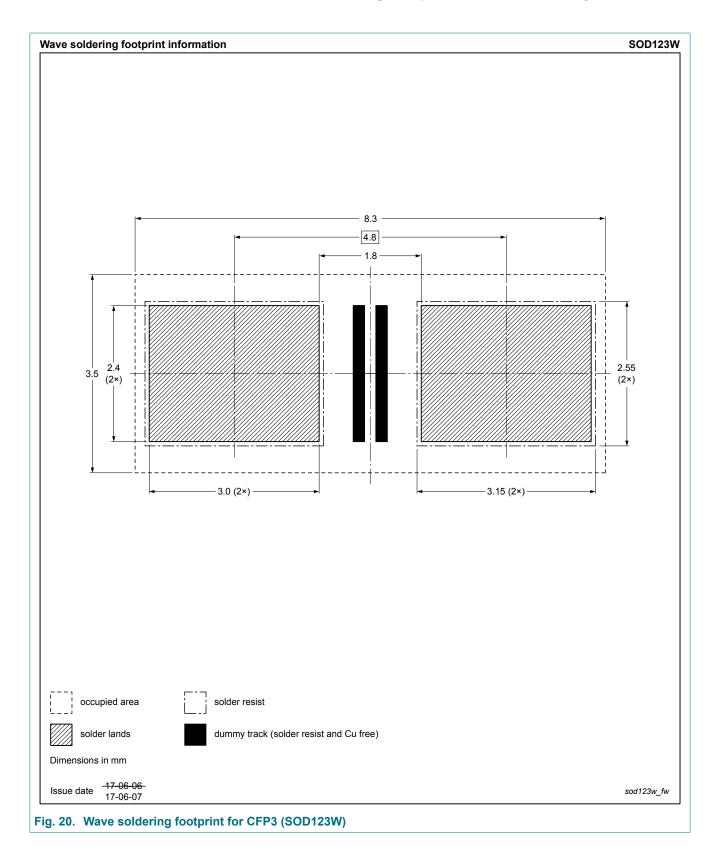
## 12. Package outline



## 13. Soldering



### High-temperature 60 V, 1 A Schottky barrier rectifier



## High-temperature 60 V, 1 A Schottky barrier rectifier

# 14. Revision history

#### Table 8. Revision history

- table of the final fin								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMEG6010ETR v.2	20180425	Product data sheet	-	PMEG6010ETR v.1				
Modifications:	<ul> <li>Features and benefits: Capable for reflow and wave soldering added</li> <li>Soldering: Wave soldering footprint added</li> </ul>							
PMEG6010ETR v.1	20121010	Product data sheet	-	-				

# High-temperature 60 V, 1 A Schottky barrier rectifier

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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PMEG6010ETR

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## High-temperature 60 V, 1 A Schottky barrier rectifier

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